

ETD 44/22/15
Core and accessories

Series/Type: B66365, B66366

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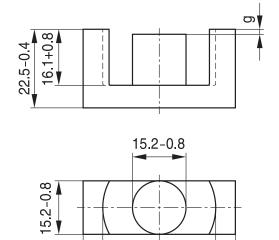
Core B66365

- To IEC 63093-6
- For SMPS transformers with optimum weight/performance ratio at small volume
- Delivery mode: single units

Magnetic characteristics (per set)

 Σ I/A = 0.6 mm⁻¹ I_e = 103 mm A_e = 173 mm² A_{min} = 172 mm² V_e = 17800 mm³

Approx. weight 94 g/set



32.5+1.6 43.8^{+1.2}_{-0.8}

FEK0767-F

Ungapped

Material	A _L value	μ_{e}	B _S	P_{V}	Ordering code
	nH		mT	W/set	
N27	3300 +30/–20%	1560	3201)	< 3.48 (200 mT, 25 kHz, 100 °C)	B66365G0000X127
N87	3500 +30/–20%	1650	3201)	< 9.40 (200 mT, 100 kHz, 100 °C)	B66365G0000X187
N97	3600 +30/–20%	1720	3201)	< 8.00 (200 mT, 100 kHz, 100 °C)	B66365G0000X197
N95	4400 +30/–20%	2085	3301)	< 8.85 (200 mT, 100 kHz, 100 °C) <10.20 (200 mT, 100 kHz, 25 °C)	

¹⁾ H = 250 A/m; f = 10 kHz; T = 100 °C

Gapped (A_L values/air gaps examples)

Material	g mm	A _L value approx. nH	μ_{e}	Ordering code ** = 27 (N27) = 87 (N87)
N27,	0.20 ±0.02	862	407	B66365G0200X1**
N87	0.50 ±0.05	438	207	B66365G0500X1**
	1.00 ±0.05	262	124	B66365G1000X1**
	1.50 ±0.05	194	92	B66365G1500X1**
	2.00 ±0.05	150	70	B66365G2000X1**

The A_L value in the table applies to a core set comprising one ungapped core (dimension g = 0 mm) and one gapped core (dimension g > 0 mm).

Other A_L values/air gaps and materials available on request — see Processing remarks on page 5.



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B66365 Core

Calculation factors (for formulas, see "E cores: general information")

Material	Relationship between air gap – A _L value		Calculation of saturation current			
	K1 (25 °C)	K2 (25 °C)	K3 (25 °C)	K4 (25 °C)	K3 (100 °C)	K4 (100 °C)
N27	262	-0.74	420	-0.847	391	-0.865
N87	262	-0.74	420	-0.796	382	-0.873

K1, K2: 0.10 mm < s < 3.50 mm Validity range:

K3, K4: 110 nH < A_L < 1060 nH



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Accessories B66366

Coil former

Material: GFR polyterephthalate, UL 94 V-0, insulation class to IEC 60085:

Valox 420-SE0 [E207780 (M)] SABIC JAPAN L L C

B66366W: H

max. operating temperature 180 °C, color code black Rynite FR 530® [E41938 (M)], E I DUPONT DE NEMOURS & CO INC

Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

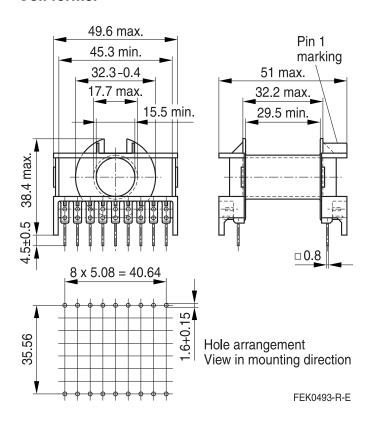
Winding: see Processing notes, 2.1

Yoke

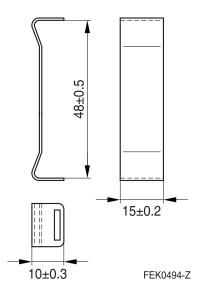
Material: Stainless spring steel (0.4 mm)

Coil former	Coil former				Ordering code
Sections	A _N mm ²	I _N mm	A_R value $\mu\Omega$	Pins	
1	210	77.7	12.7	18	B66366B1018T001 B66366W1018T001
Yoke (orde	ring code pe	er piece, 2 are i	required)	<u> </u>	B66366A2000X000

Coil former



Yoke





Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

Effects of core combination on A₁ value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

Our ferrite accessories have been designed and evaluated only in combination with our ferrite cores. We explicitly point out that our ferrite accessories or our ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

We assume no warranty or reliability for the combination of our ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "Processing notes", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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Cautions and warnings

Display of ordering codes for TDK Electronics products

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Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm ²
A_{e}	Effective magnetic cross section	mm ²
A_L	Inductance factor; $A_L = L/N^2$	nH
A_{L1}	Minimum inductance at defined high saturation ($\stackrel{\triangle}{=} \mu_a$)	nH
A _{min}	Minimum core cross section	mm ²
A _N	Winding cross section	mm ²
A_R	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6} \Omega$
В	RMS value of magnetic flux density	Vs/m ² , mT
ΔB	Flux density deviation	Vs/m ² , mT
Â	Peak value of magnetic flux density	Vs/m ² , mT
ΔÂ	Peak value of flux density deviation	Vs/m ² , mT
B _{DC}	DC magnetic flux density	Vs/m ² , mT
B _R	Remanent flux density	Vs/m ² , mT
B _S	Saturation magnetization	Vs/m ² , mT
C_0	Winding capacitance	F = As/V
CDF	Core distortion factor	mm ^{-4.5}
DF	Relative disaccommodation coefficient DF = d/μ_i	
d	Disaccommodation coefficient	
Ea	Activation energy	J
f	Frequency	s−1, Hz
f _{cutoff}	Cut-off frequency	s ⁻¹ , Hz
f _{max}	Upper frequency limit	s ⁻¹ , Hz
f _{min}	Lower frequency limit	s ⁻¹ , Hz
f _r	Resonance frequency	s ⁻¹ , Hz
f _{Cu}	Copper filling factor	·
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H_{DC}	DC field strength	A/m
H _c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 ⁻⁶ cm/A
h/µ¡²	Relative hysteresis coefficient	10 ⁻⁶ cm/A
1	RMS value of current	Α
I_{DC}	Direct current	Α
Î	Peak value of current	A
J	Polarization	Vs/m ²
k	Boltzmann constant	J/K
k ₃	Third harmonic distortion	
k _{3c}	Circuit third harmonic distortion	
I	Inductance	H = Vs/A



Symbols and terms

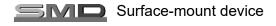
Symbol	Meaning	Unit
ΔL/L	Relative inductance change	Н
L_0	Inductance of coil without core	Н
L_H	Main inductance	Н
L_p	Parallel inductance	Н
L _{rev}	Reversible inductance	Н
L _s	Series inductance	Н
l _e	Effective magnetic path length	mm
I _N	Average length of turn	mm
N	Number of turns	
P_{Cu}	Copper (winding) losses	W
P _{trans}	Transferrable power	W
P_V	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = $\omega L/R_s$ = 1/tan δ_L)	
R	Resistance	Ω
R_{Cu}	Copper (winding) resistance (f = 0)	Ω
R _h	Hysteresis loss resistance of a core	Ω
ΔR_h	R _h change	Ω
R _i	Internal resistance	Ω
R_p	Parallel loss resistance of a core	Ω
R_s^r	Series loss resistance of a core	Ω
R _{th}	Thermal resistance	K/W
R_V	Effective loss resistance of a core	Ω
S	Total air gap	mm
Т	Temperature	°C
ΔT	Temperature difference	K
T_{C}	Curie temperature	°C
t	Time	s
t_{v}	Pulse duty factor	
tan δ	Loss factor	
tan δ_l	Loss factor of coil	
tan δ_r	(Residual) loss factor at H \rightarrow 0	
tan $\delta_{e}^{'}$	Relative loss factor	
tan δ_h	Hysteresis loss factor	
tan δ/μ _i	Relative loss factor of material at H \rightarrow 0	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V _e	Effective magnetic volume	mm ³
Z	Complex impedance	Ω
Z Z _n	Complex impedance $ Z _n = Z / N^2 \times \varepsilon (I_e / A_e)$	$\Omega \over \Omega / mm$



Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
α_{F}	Relative temperature coefficient of material	1/K
α _e	Temperature coefficient of effective permeability	1/K
r	Relative permittivity	
Þ	Magnetic flux	Vs
1	Efficiency of a transformer	
В	Hysteresis material constant	mT-1
li	Hysteresis core constant	$A^{-1}H^{-1/2}$
'S	Magnetostriction at saturation magnetization	
,	Relative complex permeability	
0	Magnetic field constant	Vs/Am
a	Relative amplitude permeability	
app	Relative apparent permeability	
е	Relative effective permeability	
i	Relative initial permeability	
p'	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
p"	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
r	Relative permeability	
rev	Relative reversible permeability	
s'	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
s S	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
tot	Relative total permeability	
	derived from the static magnetization curve	
	Resistivity	Ω m $^{-1}$
I/A	Magnetic form factor	mm ⁻¹
Cu	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
)	Angular frequency; ω = 2 Π f	s ⁻¹

All dimensions are given in mm.





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